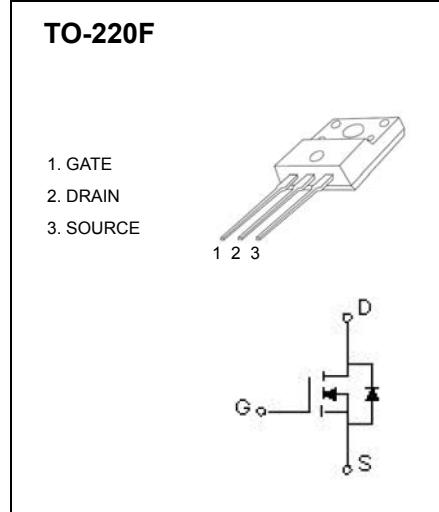


## TO-220F Plastic-Encapsulate MOSFETS

### CJPF02N60 N-Channel Power MOSFET

#### General Description

The high voltage MOSFET uses an advanced termination scheme to provide enhanced voltage-blocking capability without degrading performance over time. In addition , this advanced MOSFET is designed to withstand high energy in avalanche and commutation modes . The new energy efficient design also offers a drain-to-source diode with a fast recovery time. Designed for high voltage, high speed switching applications in power suppliers, converters and PWM motor controls , these devices are particularly well suited for bridge circuits where diode speed and commutating safe operating areas are critical and offer additional and safety margin against unexpected voltage transients.



#### FEATURES

- Robust High Voltage Termination
- Avalanche Energy Specified
- Source-to-Drain Diode Recovery Time Comparable to a Discrete Fast Recovery Diode
- Diode is Characterized for Use in Bridge Circuits
- $I_{DSS}$  and  $V_{DS(on)}$  Specified at Elevated Temperature

#### Maximum ratings ( $T_a=25^\circ\text{C}$ unless otherwise noted)

| Parameter                                   | Symbol          | Value      | Unit                      |
|---|-----------------|------------|---------------------------|
| Drain-Source Voltage                        | $V_{DS}$        | 600        | V                         |
| Gate-Source Voltage                         | $V_{GS}$        | $\pm 20$   |                           |
| Continuous Drain Current                    | $I_D$           | 2          | A                         |
| Pulsed Drain Current                        | $I_{DM}$        | 9          |                           |
| Power Dissipation                           | $P_D$           | 2          | W                         |
| Single Pulsed Avalanche Energy              | $E_{AS}^*$      | 128        | mJ                        |
| Thermal Resistance from Junction to Ambient | $R_{\theta JA}$ | 62.5       | $^\circ\text{C}/\text{W}$ |
| Junction Temperature                        | $T_J$           | 150        | $^\circ\text{C}$          |
| Storage Temperature                         | $T_{STG}$       | -55 ~ +150 |                           |

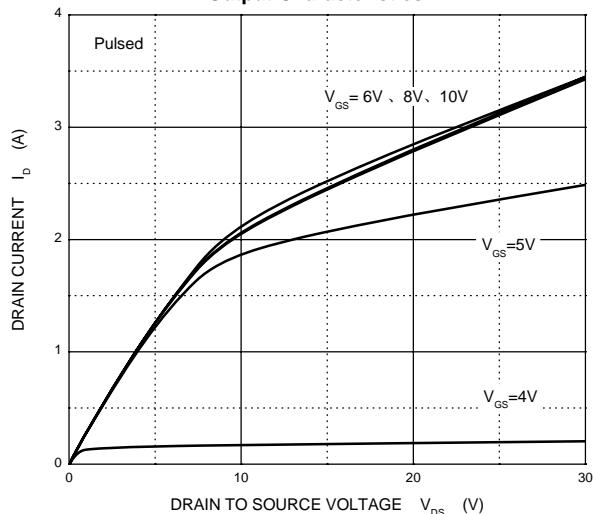
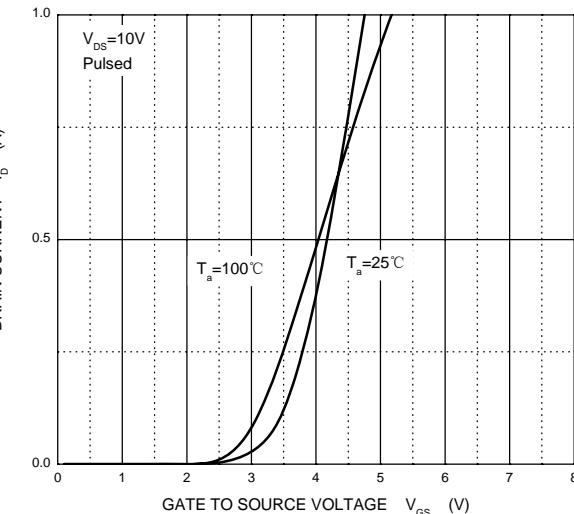
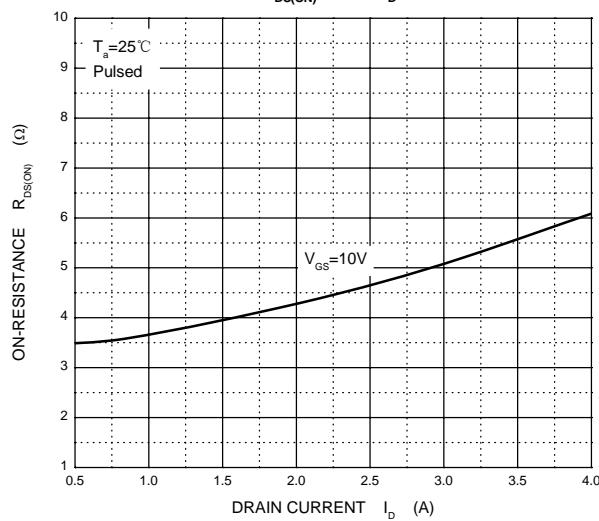
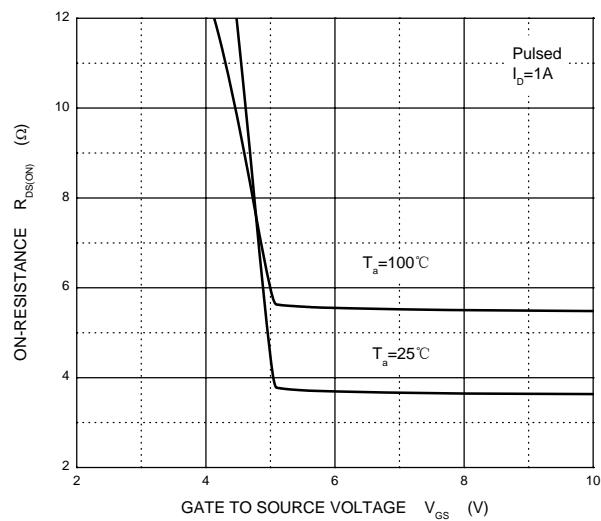
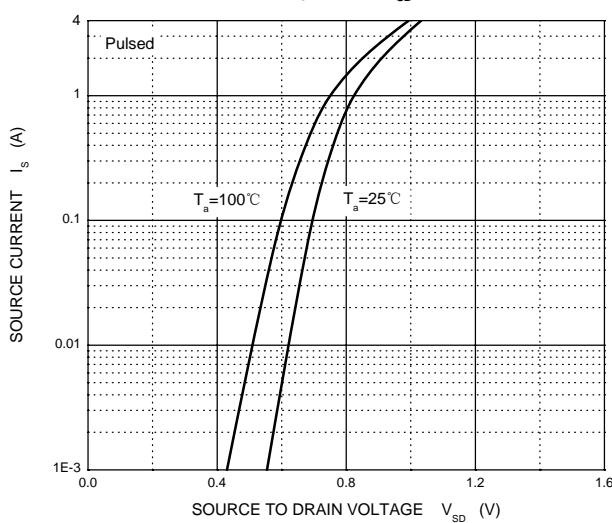
\* $E_{AS}$  condition:  $T_j=25^\circ\text{C}$ ,  $V_{DD}=50\text{V}$ ,  $L=64\text{mH}$ ,  $I_L=2\text{A}$ ,  $R_G=25\Omega$

**Electrical characteristics ( $T_a=25^\circ\text{C}$  unless otherwise noted)**

| Parameter                                | Symbol                      | Test Condition  | Min | Typ | Max       | Unit          |
|--|-----------------------------|---|-----|-----|-----------|---------------|
| Drain-Source Breakdown Voltage           | $V_{(\text{BR})\text{DSS}}$ | $V_{GS} = 0V, I_D = 250\mu\text{A}$                                 | 600 |     |           | V             |
| Gate-Threshold Voltage (note1)           | $V_{GS(\text{th})}$         | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$                             | 2.0 |     | 4.0       |               |
| Gate-Body Leakage Current (note1)        | $I_{GSS}$                   | $V_{DS} = 0V, V_{GS} = \pm 20V$                                     |     |     | $\pm 100$ | nA            |
| Zero Gate Voltage Drain Current          | $I_{DSS}$                   | $V_{DS} = 600V, V_{GS} = 0V$  |     |     | 25        | $\mu\text{A}$ |
| Drain-Source On-State Resistance (note1) | $R_{DS(\text{on})}$         | $V_{GS} = 10V, I_D = 1\text{A}$                                     |     |     | 4.4       | $\Omega$      |
| Forward Transconductance (note1)         | $g_{fs}$                    | $V_{DS} = 50V, I_D = 1\text{A}$                                     | 1   |     |           | S             |
| Input Capacitance (note 2)               | $C_{iss}$                   | $V_{DS} = 25V, V_{GS} = 0V,$<br>$f = 1\text{MHz}$                   |     | 435 |           | pF            |
| Output Capacitance (note 2)              | $C_{oss}$                   |   |     | 56  |           |               |
| Reverse Transfer Capacitance (note 2)    | $C_{rss}$                   |   |     | 9.2 |           |               |
| Turn-On Delay Time (note 2)              | $t_{d(on)}$                 | $V_{DD} = 300V, I_D = 2\text{A},$<br>$V_{GS} = 10V, R_G = 18\Omega$ |     | 12  |           | ns            |
| Rise Time (note 2)                       | $t_r$                       |   |     | 21  |           |               |
| Turn-Off Delay Time (note 2)             | $t_{d(off)}$                |   |     | 30  |           |               |
| Fall Time (note 2)                       | $t_f$                       |   |     | 24  |           |               |
| Forward on Voltage(note1)                | $V_{SD}$                    | $V_{GS} = 0V, I_S = 2\text{A}$                                      |     |     | 1.6       | V             |

**Notes:**

1. Pulse Test : Pulse width $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
2. These parameters have no way to verify.

**Output Characteristics****Transfer Characteristics** $R_{DS(ON)}$  —  $I_D$  $R_{DS(ON)}$  —  $V_{GS}$  $I_S$  —  $V_{SD}$ **Threshold Voltage**